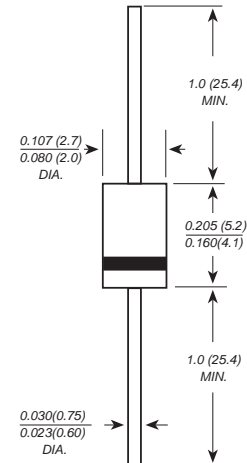


DO-41



Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Open Junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed
260°C/10 seconds at terminals



Dimensions in inches and (millimeters)

Mechanical Data

Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0088 ounce, 0.25 grams

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

| Parameter | SYMBOLS | UF4001 | UF4002 | UF4003 | UF4004 | UF4005 | UF4006 | UF4007 | UNITS |
|---|----------------|-------------|--------|--------|--------|--------|--------|--------|---------------------------|
| Maximum repetitive peak reverse voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V_{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum average forward rectified current at $T_L=100^\circ\text{C}$ | $I_{(AV)}$ | 1.0 | | | | | | | A |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I_{FSM} | 30.0 | | | | | | | A |
| Maximum instantaneous forward voltage at 1.0A | V_F | 1.0 | | 1.4 | | 1.7 | | V | |
| Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$ | I_R | 5.0 200 | | | | | | | μA |
| Maximum reverse recovery time(Note 1) | T_{rr} | 50 | | | | 75 | | | ns |
| Typical junction capacitance (Note2) | C_J | 25.0 | | | | | | | pF |
| Typical thermal resistance | R_{qJA} | 65.0 | | | | | | | $^\circ\text{C}/\text{W}$ |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +150 | | | | | | | $^\circ\text{C}$ |

Note: 1.Reverse recovery time test condition: $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{rr}=0.25\text{A}$

2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

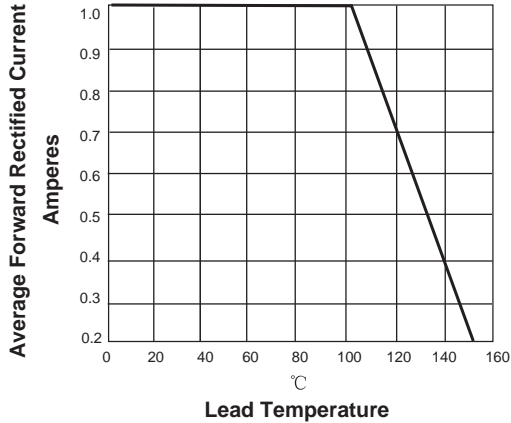


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

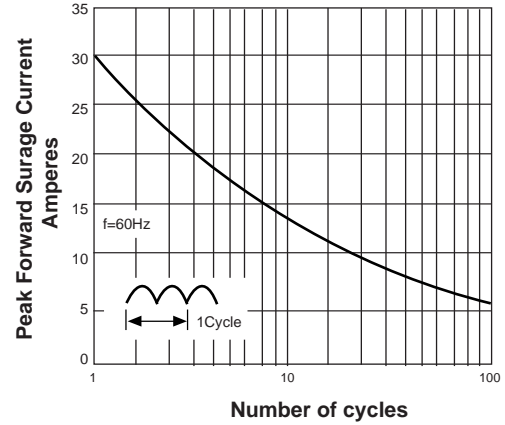


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

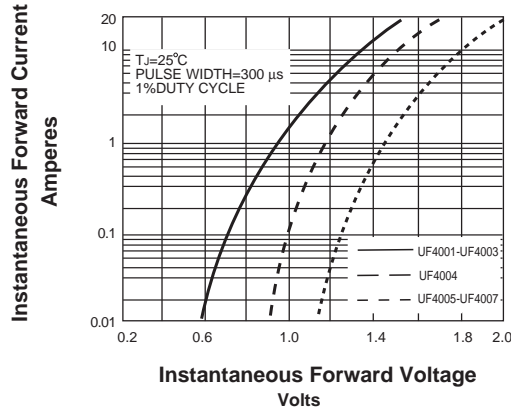
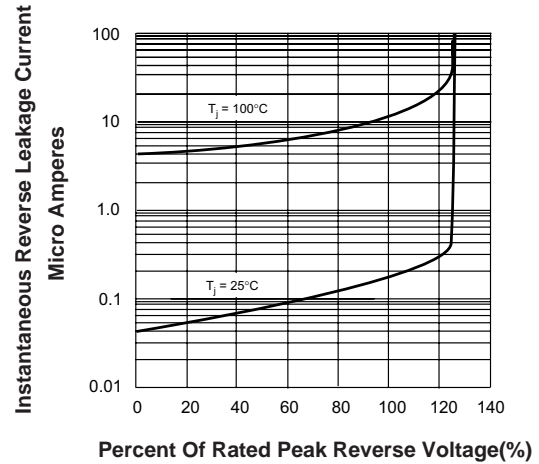
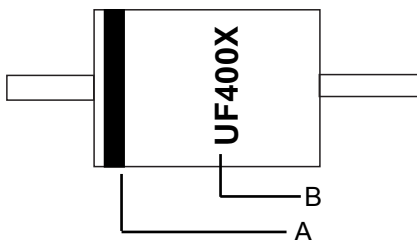


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

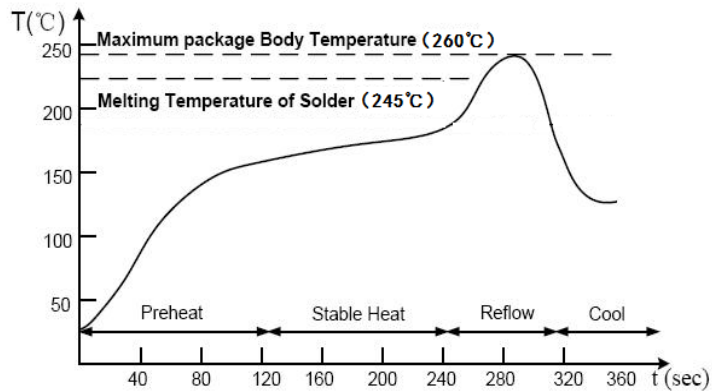


Marking



| Symbol | Explanation |
|--------|----------------------------|
| A | Color Band Denotes Cathode |
| B | Product Name,X : 1.2.....7 |

Suggested Soldering Temperature Profile

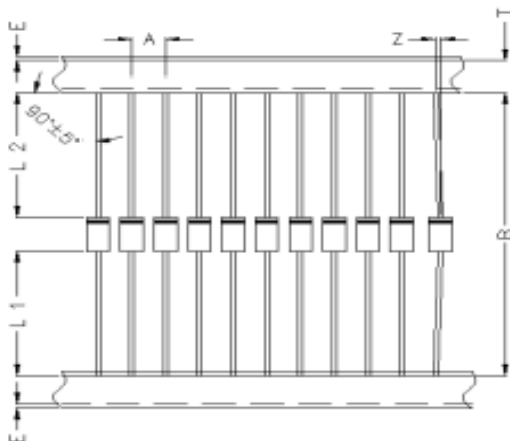


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Taping Specifications



| Item | Symbol | Specifications(mm) |
|---------------------|--------|--------------------|
| Component Pitch | A | 5.0±0.5 |
| Inner Tape Pitch | B | 52.4±1.5 |
| Component alignment | Z | 1.2 Max |
| Tape width | T | 6.0±0.5 |
| Exposed adhesive | E | 0.8 Max |
| Body eccentricity | L1-L2 | 1.0 Max |

Ammunition Package Specifications

| Package | Inner Box Size (mm) | QTY/Box (Kpcs) | Carton Size (mm) | Q'TY/Carton (Kpcs) |
|---------|---------------------|----------------|------------------|--------------------|
| DO - 41 | 255*150*75 | 5 | 420*276*312 | 50 |